

LUPOY GN5001RFH

Injection Molding, PC/ABS, Cl/Br Free Flame Retardancy

Description

General Purpose

Application

Auto, Electronics, Home Appliances, Industrial Goods, Small Devices

Properties	Condition	Method	Unit	Typical Value
Physical				
Specific Gravity	23°C	ISO 1183		1.19
Shrinkage		ISO 294-4		
Flow	2.0mm		%	0.4~0.6
Cross-flow	2.0mm		%	0.4~0.6
Melt Flow Rate	250°C, 2.16kg	ISO 1133	g/10min	12
Water Absorption	23°C, 50% RH	ISO 62	%	0.20
Mechanical				
Tensile Strength		ISO 527		
@Yield	4.0mm, 50mm/min		MPa	60
@Break	4.0mm, 50mm/min		MPa	56
Tensile Elongation		ISO 527		
@Yield	4.0mm, 50mm/min		%	4.0
@Break	4.0mm, 50mm/min		%	100
Tensile Modulus	4.0mm, 1mm/min	ISO 527	MPa	2,570
Flexural Strength	4.0mm, 2.0mm/min	ISO 178	MPa	95
Flexural Modulus	4.0mm, 2.0mm/min	ISO 178	MPa	2,360
IZOD Impact Strength		ISO 180		
4.0mm, Notched	23°C		kJ/m ²	43
	-30°C		kJ/m ²	14
	-40°C		kJ/m ²	12
Charpy Impact Strength		ISO 179		
4.0mm, Notched	23°C		kJ/m ²	45
	-30°C		kJ/m ²	13
	-40°C		kJ/m ²	12
Rockwell Hardness	R-Scale	ISO 2039		118
Shore Hardness		ISO 48-4		
Shore D	15s			
Thermal				
Melt Temperature	Peak	ISO 11357-3	°C	
Heat Deflection Temperature		ISO 75		
0.45MPa	4.0mm, Flatwise Unannealed		°C	101
1.8MPa	4.0mm, Flatwise Unannealed		°C	87
Vicat Softening Temperature	50N, 50°C/hr	ISO 306	°C	100
Coefficient of Linear Thermal Expansion		ISO 11359		
Flow	-30°C ~ 80°C		10 ⁻⁶ m/m·°C	72
Cross-flow	-30°C ~ 80°C		10 ⁻⁶ m/m·°C	79
Thermal Conductivity		ASTM E1461		

In-plane
Through-plane

W/m·K
W/m·K

Flammability

Flammability		UL94		
		mm, Class	2.50mm, 5VA	
		mm, Class	1.50mm, 5VB	
		mm, Class	0.80mm, V-2	
		mm, Class	1.20mm, V-0	
Relative Temperature Index(RTI)		UL746B		
Electrical	Min. Thickness	mm	0.80	
	Temp	°C	60	
	Max. Temp	°C	80	
Mechanical With Impact	Thickness	mm	1.50	
	Min. Thickness	mm	0.80	
	Temp	°C	60	
Mechanical Without Impact	Max. Temp	°C	80	
	Thickness	mm	1.50	
	Min. Thickness	mm	0.80	
	Temp	°C	60	
	Max. Temp	°C	85	
	Thickness	mm	1.50	

Electrical

Comparative Tracking Index(CTI)	Solution A	UL746A	PLC	2
Surface Resistivity	23°C	IEC60093	Ohm	1E+15
Volume Resistivity	23°C	IEC60093	Ohm·m	1E+15
Dielectric Constant	23°C	ASTM D150		2.8
Dielectric Strength	23°C, 2.0mm	ASTM D149	kV/mm	20
EMI Shield	1GHz, 3.0mm	ASTM D4935	dB	

Note) Typical values can be used only for the purpose of selecting material, and there can be variation within normal tolerances for various colors.

Values given should not be interpreted as specification and not be used for designing part or tool.

All properties, except melt flow rate are measured by injection molded specimens after 48 hours storage at 23°C, 50% relative humidity.

Issued Date : 2022-12-26

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Processing Conditions (Injection Molding)

Processing Parameters	Unit	Value	
Drying Temperature	°C	75~85	
Drying Time	hrs	3~5	
Maximum Moisture Content	%	0.02	
Melt Temperature	°C	235~265	
Cylinder Temperature	Rear	°C	220~240
	Middle	°C	235~255
	Front	°C	250~265
Nozzle Temperature	°C	250~265	
Mold Temperature	°C	50~80	

Note) These guides may not apply directly or need adjustment in specific situations such as low shot sizes, thin wall molding and gas-assist molding and so on.